Unit: mm

TOSHIBA Diode Silicon Epitaxial Planar Diode

# **1SS397**

#### High Voltage, High Speed Switching Applications

 $\begin{array}{ll} \bullet & \text{Low forward voltage} & : V_F = 1.0V \text{ (typ.)} \\ \bullet & \text{High voltage} & : V_R = 400V \text{ (min.)} \\ \bullet & \text{Fast reverse recovery time: } t_{rr} = 0.5 \mu \text{s (typ.)} \\ \bullet & \text{Small total capacitance} & : C_T = 2.5 pF \text{ (typ.)} \\ \end{array}$ 

• Small package : SC-70

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse Voltage	$V_{RM}$	420	V
Reverse voltage	V <sub>R</sub>	400	V
Maximum (peak) forward current	I <sub>FM</sub>	300	mA
Average forward current	Io	100	mA
Surge current (10ms)	I <sub>FSM</sub>	2	Α
Power dissipation	Р	100	mW
Junction temperature	Tj	125	°C
Storage temperature range	T <sub>stg</sub>	<b>-</b> 55~125	°C

2.1±0.1 1.25±0.1 1. ANODE 2. N.C. USM 3. CATHODE

JEDEC

JEITA SC-70

TOSHIBA 1-2P1D

Weight: 0.006g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high

temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

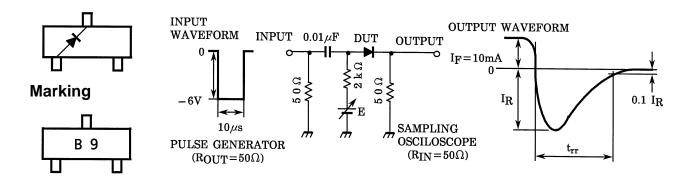
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Electrical Characteristics (Ta = 25°C)**

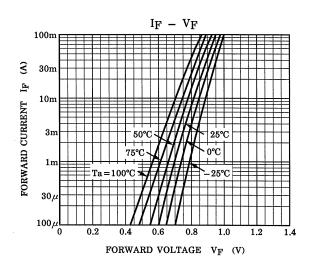
Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V <sub>F (1)</sub>	_	I <sub>F</sub> = 10mA	_	0.8	_	V
	V <sub>F (2)</sub>	_	I <sub>F</sub> = 100mA	_	1.0	1.3	
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 300V	_	_	0.1	μΑ
	I <sub>R (2)</sub>	_	V <sub>R</sub> = 400V	_	_	1.0	
Total capacitance	C <sub>T</sub>	_	V <sub>R</sub> = 0, f = 1MH <sub>z</sub>	_	2.5	5.0	pF
Reverse recovery time	t <sub>rr</sub>	_	I <sub>F</sub> = 10mA (Fig.1)	_	0.5	_	μs

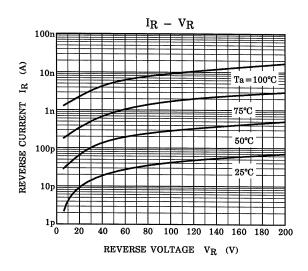
# **Equivalent Circuit** F

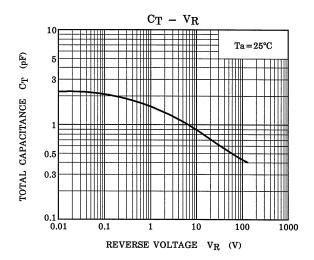
Fig.1 Reverse Recovery Time (t<sub>rr</sub>) Test Circuit(Top View)

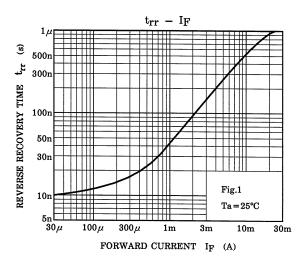


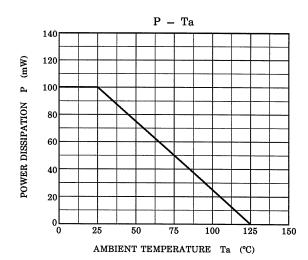
2 2007-11-01











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